

Vishay Semiconductors

HALOGEN

FREE

Small Signal Switching Diodes, Low Leakage Current



FEATURES

- Silicon planar diodes
- · Saving space
- · Hermetic sealed parts
- Fits onto SOD-323/SOT-23 footprints
- Electrical data identical with the devices BAQ33 to BAQ35, BAQ133 to BAQ135
- Very low reverse current
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



• Protection circuits, time delay circuits, peak follower circuits, logarithmic amplifiers



DESIGN SUPPORT TOOLS click logo to get started



MECHANICAL DATA

Case: MicroMELF Weight: approx. 12 mg Cathode band color: black Packaging codes / options:

TR3/10K per 13" reel (8 mm tape), 10K/box TR/2.5K per 7" reel (8 mm tape), 12.5K/box

PARTS TABLE							
PART	TYPE DIFFERENTIATION	ORDERING CODE	CIRCUIT CONFIGURATION	REMARKS			
BAQ333	$V_{RRM} = 40 \text{ V}$	BAQ333-TR3 or BAQ333-TR	Single	Tape and reel			
BAQ334	V _{RRM} = 70 V	BAQ334-TR3 or BAQ334-TR	Single	Tape and reel			
BAQ335	V _{RRM} = 140 V	BAQ335-TR3 or BAQ335-TR	Single	Tape and reel			

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT	
		BAQ333	V_{RRM}	40	V	
Repetitive peak reverse voltage		BAQ334	V_{RRM}	70	V	
		BAQ335	V_{RRM}	140	V	
		BAQ333	V_R	30	V	
Reverse voltage		BAQ334	V_R	60	V	
		BAQ335	V_R	125	V	
Peak forward surge current	t _p = 1 μs		I _{FSM}	2	А	
Forward continuous current			l _F	200	mA	

THERMAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Thermal resistance junction to ambient air	Mounted on epoxy-glass hard tissue, fig. 4 35 µm copper clad, 0.9 mm ² copper area per electrode	R_{thJA}	500	K/W		
Junction temperature		Tj	175	°C		
Storage temperature range		T _{stg}	-65 to +175	°C		



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ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 100 mA		V_{F}			1	V
	E ≤ 300 lx, rated V _R		I _R		1	3	nA
	$E \le 300 \text{ lx}$, rated V_R , $T_j = 125 ^{\circ}\text{C}$		I _R			0.5	μΑ
Reverse current	E ≤ 300 lx, V _R = 15 V	BAQ333	I _R		0.5	1	nA
	$E \le 300 \text{ lx}, V_R = 30 \text{ V}$	BAQ334	I _R		0.5	1	nA
	$E \le 300 Ix, V_R = 60 V$	BAQ335	I _R		0.5	1	nA
	$I_R = 5 \mu A, t_p/T = 0.01,$ $t_p = 0.3 \text{ ms}$	BAQ333	V _(BR)	40			V
Breakdown voltage		BAQ334	V _(BR)	70			V
		BAQ335	V _(BR)	140			V
Diode capacitance	V _R = 0 V, f = 1 MHz		C _D			3	pF

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

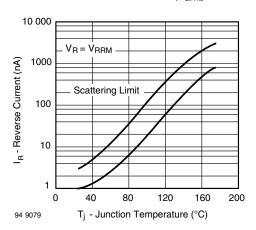


Fig. 1 - Reverse Current vs. Junction Temperature

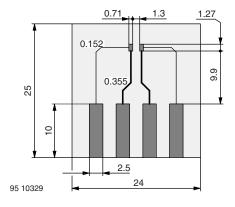


Fig. 3 - Board for R_{thJA} Definition (in mm)

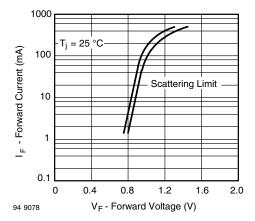


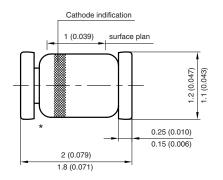
Fig. 2 - Forward Current vs. Forward Voltage

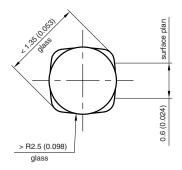


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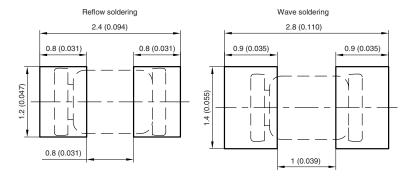
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PACKAGE DIMENSIONS in millimeters (inches): MicroMELF





Foot print recommendation:



Created - Date: 26.July.1996 Rev. 13 - Date: 07.June.2006 Document no.:6.560-5007.01-4 96 12072

^{*} The gap between plug and glass can be either on cathode or anode side



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